SONY



Diagonal 6mm (Type 1/3) Progressive Scan CCD Image Sensor with Square Pixel for Color Cameras

Description

The ICX084AK is a diagonal 6mm (Type 1/3) interline CCD solid-state image sensor with a square pixel array which supports VGA format. Progressive scan allows all pixels signals to be output independently within approximately 1/30 second. This chip features an electronic shutter with variable charge-storage time which makes it possible to realize full-frame still image without a mechanical shutter. High resolution and high color reproductivity are achieved through the use of R, G, B primary color mosaic filters. Further, high sensitivity and low dark current are achieved through the adoption of HAD (Hole-Accumulation Diode) sensors.

This chip is suitable for applications such as electronic still cameras, PC input cameras, etc.

Features

- Progressive scan allows individual readout of the image signals from all pixels.
- High vertical resolution (480TV-lines) still image without a mechanical shutter.
- Square pixel unit cell
- Supports VGA format
- Horizontal drive frequency: 12.27MHz
- No voltage adjustments (reset gate and substrate bias are not adjusted.)
- R, G, B primary color mosaic filters on chip
- High resolution, high color reproductivity, high sensitivity, low dark current
- Continuous variable-speed shutter 1/30 (typ.) to 1/10000s
- Low smear
- Excellent antiblooming characteristics
- Horizontal register: 5V drive
- 16-pin high precision plastic package (enables dualsurface standard)

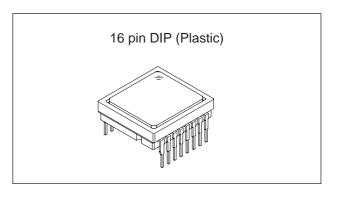
Device Structure

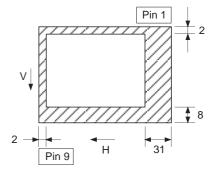
- Interline CCD image sensor
- Image size:
- Number of effective pixels:
- Total number of pixels:
- Chip size:
- Unit cell size:
- Optical black:
- Number of dummy bits:
- Substrate material:
- Diagonal 6mm (Type 1/3) 659 (H) \times 494 (V) approx. 330K pixels 692 (H) \times 504 (V) approx. 350K pixels 5.84mm (H) \times 4.94mm (V) 7.4µm (H) \times 7.4µm (V) Horizontal (H) direction: Front 2 pixels, rear 31 pixels Vertical (V) direction: Front 8 pixels, rear 2 pixels Horizontal 16 Vertical 5 Silicon



* Wfine CCD is a registered trademark of Sony Corporation. Represents a CCD adopting progressive scan, primary color filter and square pixel.

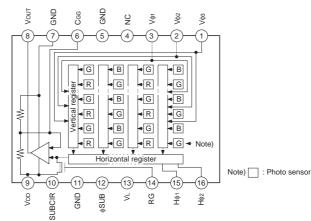
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Optical black position (Top View) **Block Diagram and Pin Configuration**

(Top View)



Pin Description

| Pin No. | Symbol | Description | Pin No. | Symbol | Description |
|---------|--------|----------------------------------|---------|--------|---|
| 1 | Vфз | Vertical register transfer clock | 9 | Vdd | Supply voltage |
| 2 | Vφ2 | Vertical register transfer clock | 10 | SUBCIR | Supply voltage for the substrate voltage generation |
| 3 | Vφ1 | Vertical register transfer clock | 11 | GND | GND |
| 4 | NC | | 12 | φSUB | Substrate clock |
| 5 | GND | GND | 13 | VL | Protective transistor bias |
| 6 | CGG | Output amplifier gate*1 | 14 | RG | Reset gate clock |
| 7 | GND | GND | 15 | Ηφ1 | Horizontal register transfer clock |
| 8 | Vout | Signal output | 16 | Ηφ2 | Horizontal register transfer clock |

*1 DC bias is applied within the CCD, so that this pin should be grounded externally through a capacitance of 1000pF or more.

Absolute Maximum Ratings

| | Item | Ratings | Unit | Remarks |
|-------------------------|-------------------------------------|---------------|------|---------|
| Substrate clock | – GND | -0.3 to +36 | V | |
| Supply voltage | VDD, VOUT, CGG, SUBCIR – GND | -0.3 to +18 | V | |
| Supply voltage | VDD, VOUT, CGG, SUBCIR – ϕ SUB | -22 to +9 | V | |
| | Vφ1, Vφ2, Vφ3 – GND | -15 to +16 | V | |
| Clock input voltage | Vφ1, Vφ2, Vφ3 – φSUB | to +10 | V | |
| Voltage difference betw | ween vertical clock input pins | to +15 | V | *2 |
| Voltage difference betw | ween horizontal clock input pins | to +16 | V | |
| Ηφ1, Ηφ2 – Vφ3 | | -16 to +16 | V | |
| Hφ1, Hφ2 – GND | | -10 to +15 | V | |
| Ηφ1, Ηφ2-φSUB | | -55 to +10 | V | |
| V∟– | | -65 to +0.3 | V | |
| Vφ2, Vφ3 – VL | | -0.3 to +27.5 | V | |
| RG – GND | | -0.3 to +20.5 | V | |
| Vφ1, Hφ1, Hφ2, GND – V | /L | -0.3 to +17.5 | V | |
| Storage temperature | | -30 to +80 | °C | |
| Operating temperature | | -10 to +60 | °C | |

*2 +24V (Max.) when clock width < 10 μ s, clock duty factor < 0.1%.

Bias Conditions

| Item | Symbol | Min. | Тур. | Max. | Unit | Remarks |
|----------------------------|--------|-------|------|-------|------|---------|
| Supply voltage | Vdd | 14.55 | 15.0 | 15.45 | V | |
| Protective transistor bias | VL | | | | | |
| Substrate clock | ¢SUB | | | | | |

*1 VL setting is the VvL voltage of the vertical transfer clock waveform, or the same power supply as the VL power supply for the V driver should be used.

 \ast_2 Set SUBCIR pin to open when applying a DC bias to the substrate clock pin.

DC Characteristics

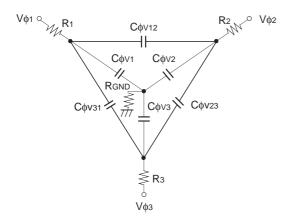
| Item | Symbol | Min. | Тур. | Max. | Unit | Remarks |
|----------------|--------|------|------|------|------|---------|
| Supply current | Idd | | 6 | 8 | mA | |

Clock Voltage Conditions

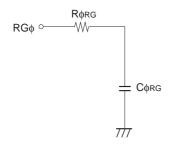
| Item | Symbol | Min. | Тур. | Max. | Unit | Waveform diagram | Remarks |
|-----------------------------|------------------|-------------|-------------|-------------|------|---------------------|----------------------------------|
| Readout clock voltage | Vvт | 14.55 | 15.0 | 15.45 | V | 1 | |
| | Vvh02 | -0.05 | 0 | 0.05 | V | 2 | VVH = VVH02 |
| | Vvh1, Vvh2, Vvh3 | -0.2 | 0 | 0.05 | V | 2 | |
| | VVL1, VVL2, VVL3 | -8.0 | -7.5 | -7.0 | V | 2 | VvL = (VvL1 + VvL3)/2 |
| Vertical transfer clock | Vφ1, Vφ2, Vφ3 | 6.8 | 7.5 | 8.05 | V | 2 | |
| voltage | I Vvl1 – Vvl3 I | | | 0.1 | V | 2 | |
| | Vvнн | | | 1.0 | V | 2 | High-level coupling |
| | Vvhl | | | 2.3 | V | 2 | High-level coupling |
| | Vvlh | | | 1.0 | V | 2 | Low-level coupling |
| | Vvll | | | 1.0 | V | 2 | Low-level coupling |
| Horizontal transfer | Vфн | 4.75 | 5.0 | 5.25 | V | 3 | |
| clock voltage | VHL | -0.05 | 0 | 0.05 | V | 3 | |
| | Vørg | 4.5 | 5.0 | 5.5 | V | 4 | Input through 0.01µF capacitance |
| Reset gate clock voltage | Vrglh – Vrgll | | | 0.8 | V | 4 | Low-level coupling |
| | Vrgh | Vdd +0.4 | Vdd +0.6 | Vdd +0.8 | V | 4 | |
| Substrate clock voltage | Vфsuв | 21.5 | 22.5 | 23.5 | V | 5 | |

Clock Equivalent Circuit Constant

| Item | Symbol | Min. | Тур. | Max. | Unit | Remarks |
|--|--------------|------|------|------|------|---------|
| | Cφ∨1 | | 560 | | pF | |
| Capacitance between vertical transfer clock and GND | C φv2 | | 470 | | pF | |
| | Сфvз | | 1500 | | pF | |
| | СфV12 | | 1500 | | pF | |
| Capacitance between vertical transfer clocks | Сфv23 | | 1500 | | pF | |
| | Сф∨з1 | | 1000 | | pF | |
| Capacitance between horizontal transfer clock and GND | Сфн1, Сфн2 | | 43 | | pF | |
| Capacitance between horizontal transfer clocks | Сфнн | | 39 | | pF | |
| Capacitance between reset gate clock and GND | Cørg | | 5 | | pF | |
| Capacitance between substrate clock and GND | Сфѕив | | 570 | | pF | |
| Vertical transfer clock series resistor | R1, R2 | | 20 | | Ω | |
| | R3 | | 56 | | Ω | |
| Vertical transfer clock ground resistor | Rgnd | | 43 | | Ω | |
| Horizontal transfer clock series resistor | Rфн1, Rфн2 | | 10 | | Ω | |
| Reset gate clock series resistor | Rørg | | 39 | | Ω | |



Vertical transfer clock equivalent circuit

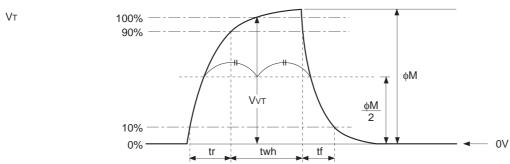


Reset gate clock equivalent circuit



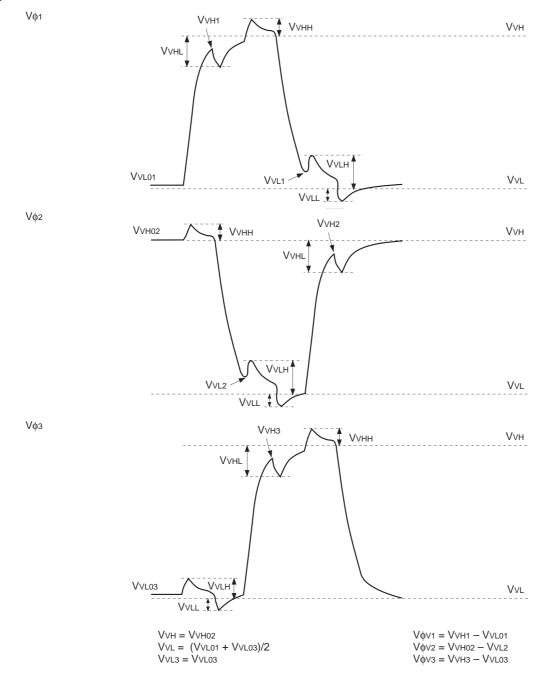
Drive Clock Waveform Conditions

(1) Readout clock waveform

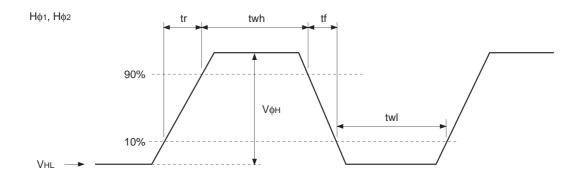


Note) Readout clock is used by composing vertical transfer clocks V $_{\varphi 2}$ and V $_{\varphi 3}.$

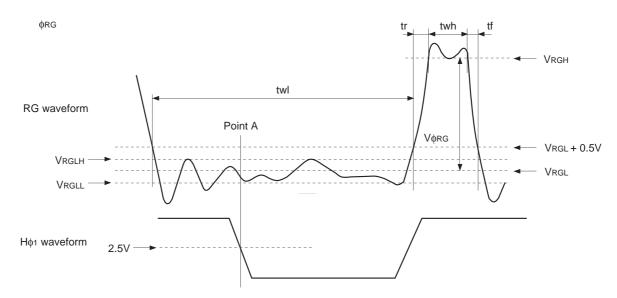
(2) Vertical transfer clock waveform



(3) Horizontal transfer clock waveform



(4) Reset gate clock waveform



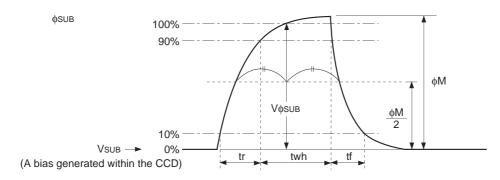
VRGLH is the maximum value and VRGLL is the minimum value of the coupling waveform during the period from Point A in the above diagram until the rising edge of RG. In addition, VRGL is the average value of VRGLH and VRGLL.

VRGL = (VRGLH + VRGLL)/2

Assuming VRGH is the minimum value during the interval twh, then:

 $V \phi RG = V RGH - V RGL$

(5) Substrate clock waveform



Clock Switching Characteristics

| | ltem | Symbol | | twh | | | twl | | tr | | tf | | | Unit | Remarks | |
|---------------------------|-------------------------|------------------|------|------|------|------|------|------|------|------|------|------|------|------|---------|------------------------|
| | nem | Symbol | Min. | Тур. | Max. | Onit | Remarks |
| R | eadout clock | Vτ | 2.3 | 2.5 | | | | | | 0.5 | | | 0.5 | | μs | During readout |
| | ertical transfer ock | Vφ1, Vφ2, Vφ3 | | | | | | | | | | 15 | | 350 | ns | *1 |
| clock | During imaging | Ηφ1 | 24 | 30 | | 25 | 31.5 | | | 10 | 17.5 | | 10 | 17.5 | ns | *2 |
| Horizontal transfer clock | During imaging | Hø2 | 26.5 | 31.5 | | 25 | 30 | | | 10 | 15 | | 10 | 15 | | _ |
| ontal tr | During parallel- | Hφ1 | | | | | | | | 0.01 | | | 0.01 | | μs | |
| Horizo | serial conversion | Ηφ2 | | | | | | | | 0.01 | | | 0.01 | | μο | |
| R | eset gate clock | φRG | 11 | 13 | | | 62.5 | | | 3 | | | 3 | | ns | |
| Sı | ubstrate clock | фѕив | 1.5 | 1.8 | | | | | | | 0.5 | | | 0.5 | μs | During drain charge |

*1 When vertical transfer clock driver CXD1267AN is used.

| ltom | 0 salad | | two | | ا ا ما ا | Demerica | |
|---------------------------|----------|------|------|------|----------|----------|--|
| Item | Symbol | Min. | Тур. | Max. | Unit | Remarks | |
| Horizontal transfer clock | Ηφ1, Ηφ2 | 21.5 | 25.5 | | ns | *3 | |

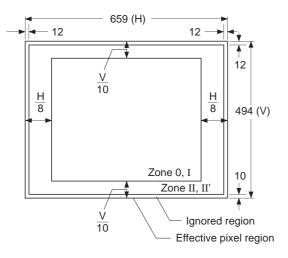
*3 The overlap period for twh and twl of horizontal transfer clocks H ϕ_1 and H ϕ_2 is two.

Image Sensor Characteristics

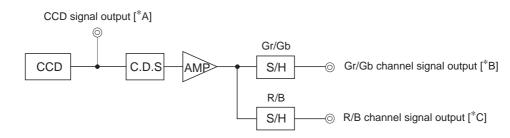
(Ta = 25°C)

| Item | | Symbol | Min. | Тур. | Max. | Unit | Measurement method | Remarks |
|-------------------|----------|--------|------|-------|-------|------|--------------------|---------------|
| G sensitivity | | Sg | 300 | 450 | | mV | 1 | |
| Sensitivity | R | Rr | 0.3 | 0.45 | 0.6 | | 1 | |
| comparison | В | Rb | 0.4 | 0.55 | 0.7 | | 1 | |
| Saturation signal | | Vsat | 500 | | | mV | 2 | Ta = 60°C |
| Smear | | Sm | | 0.005 | 0.015 | % | 3 | |
| Video signal shad | dina | SHa | | | 20 | % | 4 | Zone 0 and I |
| | ung | SHg | | | 25 | % | 4 | Zone 0 to II' |
| Uniformity betwee | en video | ∆Srg | | | 8 | % | 5 | |
| signal channels | | ∆Sbg | | | 8 | % | 5 | |
| Dark signal | | Vdt | | | 4 | mV | 6 | Ta = 60°C |
| Dark signal shad | ing | ΔVdt | | | 1 | mV | 7 | Ta = 60°C |
| Line crawl G | | Lcg | | | 3.8 | % | 8 | |
| Line crawl R | | Lcr | | | 3.8 | % | 8 | |
| Line crawl B | | Lcb | | | 3.8 | % | 8 | |
| Lag | | Lag | | | 0.5 | % | 9 | |

Zone Definition of Video Signal Shading



Measurement System



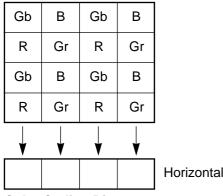
Note) Adjust the amplifier gain so that the gain between [*A] and [*B], and between [*A] and [*C] equals 1.

Image Sensor Characteristics Measurement Method

© Measurement conditions

- 1) In the following measurements, the device drive conditions are at the typical values of the bias and clock voltage conditions.
- 2) In the following measurements, spot blemishes are excluded and, unless otherwise specified, the optical black level (OB) is used as the reference for the signal output, which is taken as the value of the Gr/Gb signal output or the R/B signal output of the measurement system.

O Color coding and readout of this image sensor



The primary color filters of this image sensor are arranged in the layout shown in the figure on the left (Bayer arrangement). Gr and Gb denote the G signals on the same line as the R signal and the B signal, respectively.

Horizontal register

Color Coding Diagram

All pixels signals are output successively in a 1/30s period.

The R signal and Gr signal lines and the Gb signal and B signal lines are output successively.

◎ Definition of standard imaging conditions

1) Standard imaging condition I :

Use a pattern box (luminance 706cd/m², color temperature of 3200K halogen source) as a subject. (Pattern for evaluation is not applicable.) Use a testing standard lens with CM500S (t = 1.0mm) as an IR cut filter and image at F5.6. The luminous intensity to the sensor receiving surface at this point is defined as the standard sensitivity testing luminous intensity.

2) Standard imaging condition II :

Image a light source (color temperature of 3200K) with a uniformity of brightness within 2% at all angles. Use a testing standard lens with CM500S (t = 1.0mm) as an IR cut filter. The luminous intensity is adjusted to the value indicated in each testing item by the lens diaphragm.

1. G sensitivity, sensitivity comparison

Set to standard imaging condition I. After selecting the electronic shutter mode with a shutter speed of 1/100s, measure the signal outputs (V_{Gr}, V_{Gb}, V_R and V_B) at the center of each Gr, Gb, R and B channel screens, and substitute the values into the following formula.

$$V_{G} = (V_{Gr} + V_{Gb})/2$$

$$Sg = V_{G} \times \frac{100}{30} [mV]$$

$$Rr = V_{R}/V_{G}$$

$$Rb = V_{B}/V_{G}$$

2. Saturation signal

Set to standard imaging condition II. After adjusting the luminous intensity to 20 times the intensity with the average value of the Gr signal output, 150mV, measure the minimum values of the Gr, Gb, R and B signal outputs.

3. Smear

Set to standard imaging condition II. With the lens diaphragm at F5.6 to F8, first adjust the average value of the Gr signal output to 150mV. Measure the average values of the Gr signal output, Gb signal output, R signal output and B signal output (Gra, Gba, Ra and Ba), and then adjust the luminous intensity to 500 times the intensity with average value of the Gr signal output, 150mV. After the readout clock is stopped and the charge drain is executed by the electronic shutter at the respective H blankings, measure the maximum value (Vsm [mV]), independent of the Gr, Gb, R and B signal outputs, and substitute the values into the following formula.

 $Sm = V_{Sm} \div \frac{Gra + Gba + Ra + Ba}{4} \times \frac{1}{500} \times \frac{1}{10} \times 100 \text{ [\%] (1/10V method conversion value)}$

4. Video signal shading

Set to standard imaging condition II. With the lens diaphragm at F5.6 to F8, adjust the luminous intensity so that the average value of the Gr signal output is 150mV. Then measure the maximum (Grmax [mV]) and minimum (Grmin [mV]) values of the Gr signal output and substitute the values into the following formula.

$$SHg = (Grmax - Grmin)/150 \times 100 [\%]$$

5. Uniformity between video signal channels

After measuring 4, measure the maximum (Rmax [mV]) and minimum (Rmin [mV]) values of the R signal and the maximum (Bmax [mV]) and minimum (Bmin [mV]) values of the B signal, and substitute the values into the following formula.

 $\Delta Srg = (Rmax - Rmin)/150 \times 100 [\%]$ $\Delta Sbg = (Bmax - Bmin)/150 \times 100 [\%]$

6. Dark signal

Measure the average value of the signal output (Vdt [mV]) with the device ambient temperature 60°C and the device in the light-obstructed state, using the horizontal idle transfer level as a reference.

7. Dark signal shading

After measuring 6, measure the maximum (Vdmax [mV]) and minimum (Vdmin [mV]) values of the dark signal output and substitute the values into the following formula.

 $\Delta Vdt = Vdmax - Vdmin [mV]$

8. Line crawl

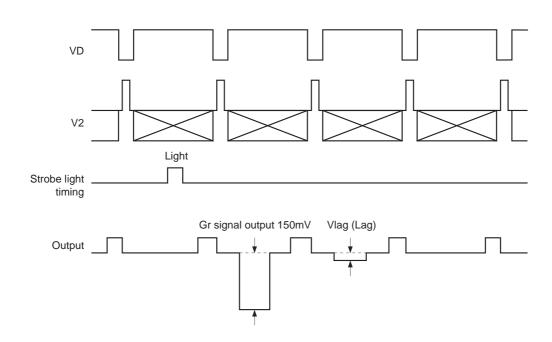
Set to standard imaging condition II. Adjust the luminous intensity so that the average value of the Gr signal output is 150mV, and then insert R, G, and B filters and measure the difference between G signal lines (Δ Glr, Δ Glg, Δ Glb [mV]) as well as the average value of the G signal output (Gar, Gag, Gab). Substitute the values into the following formula.

$$Lci = \frac{\Delta Gli}{Gai} \times 100 \text{ [\%]} (i = r, g, b)$$

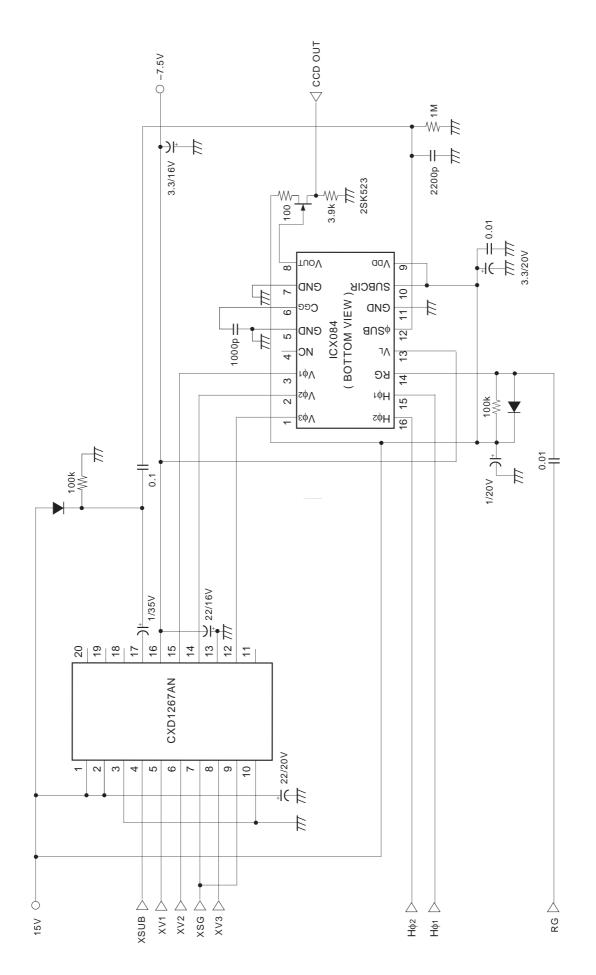
Lag = (Vlag/150) × 100 [%]

9. Lag

Adjust the Gr signal output value generated by strobe light to 150mV. After setting the strobe light so that it strobes with the following timing, measure the residual signal (Vlag). Substitute the value into the following formula.



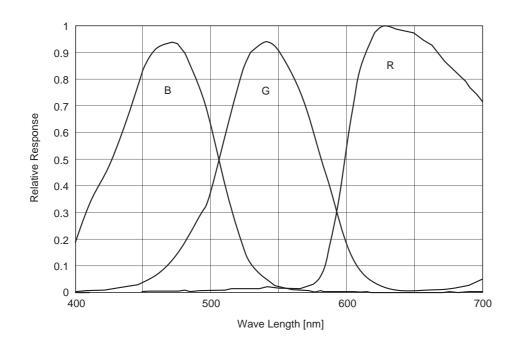




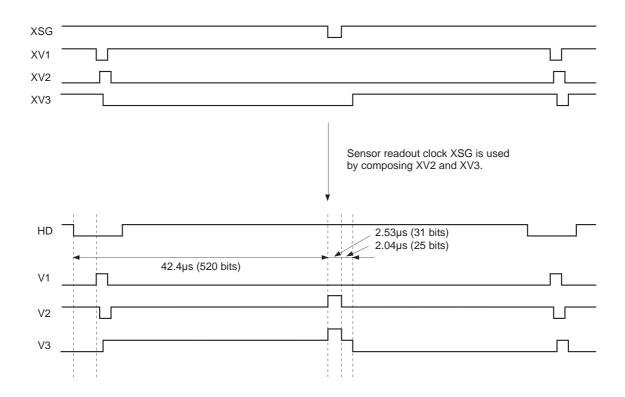
Drive Circuit

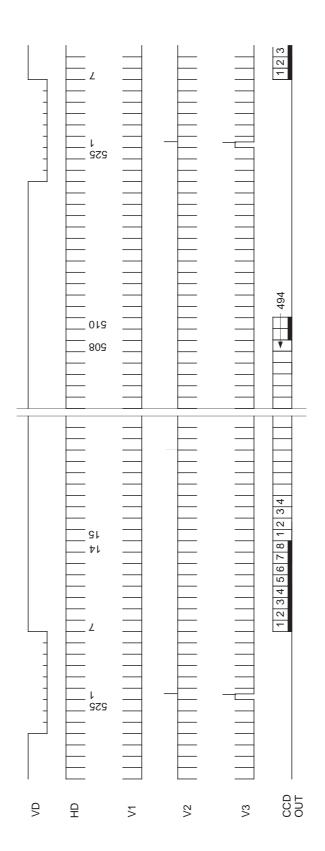
Spectral Sensitivity Characteristics

(Includes lens characteristics, excludes light source characteristics)



Sensor Readout Clock Timing Chart





| 251 251 251 252 | | | | | |
|---|------------------|--|--|------|-----|
| و ۲۵۱ - - - - - - - - - - - - - - - - - - - | | ULULULULULULULULULULULULULULULULULULUL | 1 12 1 24 1 26 1 12 1 12 1 12 | | |
| 39 | | | | | |
| HD/SYNC BLK | CLK RG SHP | SHD V1 | V2 V3 | H2 H | SUB |



Notes on Handling

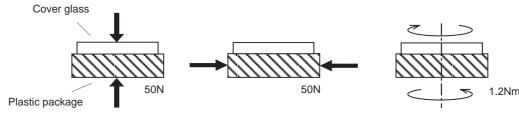
1) Static charge prevention

CCD image sensors are easily damaged by static discharge. Before handling be sure to take the following protective measures.

- a) Either handle bare handed or use non-chargeable gloves, clothes or material. Also use conductive shoes.
- b) When handling directly use an earth band.
- c) Install a conductive mat on the floor or working table to prevent the generation of static electricity.
- d) Ionized air is recommended for discharge when handling CCD image sensor.
- e) For the shipment of mounted substrates, use boxes treated for the prevention of static charges.
- 2) Soldering
 - a) Make sure the package temperature does not exceed 80°C.
 - b) Solder dipping in a mounting furnace causes damage to the glass and other defects. Use a ground 30W soldering iron and solder each pin in less than 2 seconds. For repairs and remount, cool sufficiently.
 - c) To dismount an image sensor, do not use a solder suction equipment. When using an electric desoldering tool, use a thermal controller of the zero cross On/Off type and connect it to ground.
- 3) Dust and dirt protection

Image sensors are packed and delivered by taking care of protecting its glass plates from harmful dust and dirt. Clean glass plates with the following operation as required, and use them.

- a) Perform all assembly operations in a clean room (class 1000 or less).
- b) Do not either touch glass plates by hand or have any object come in contact with glass surfaces. Should dirt stick to a glass surface, blow it off with an air blower. (For dirt stuck through static electricity ionized air is recommended.)
- c) Clean with a cotton bud and ethyl alcohol if the grease stained. Be careful not to scratch the glass.
- d) Keep in a case to protect from dust and dirt. To prevent dew condensation, preheat or precool when moving to a room with great temperature differences.
- e) When a protective tape is applied before shipping, just before use remove the tape applied for electrostatic protection. Do not reuse the tape.
- 4) Installing (attaching)
 - a) Remain within the following limits when applying a static load to the package. Do not apply any load more than 0.7mm inside the outer perimeter of the glass portion, and do not apply any load or impact to limited portions. (This may cause cracks in the package.)



Compressive strength

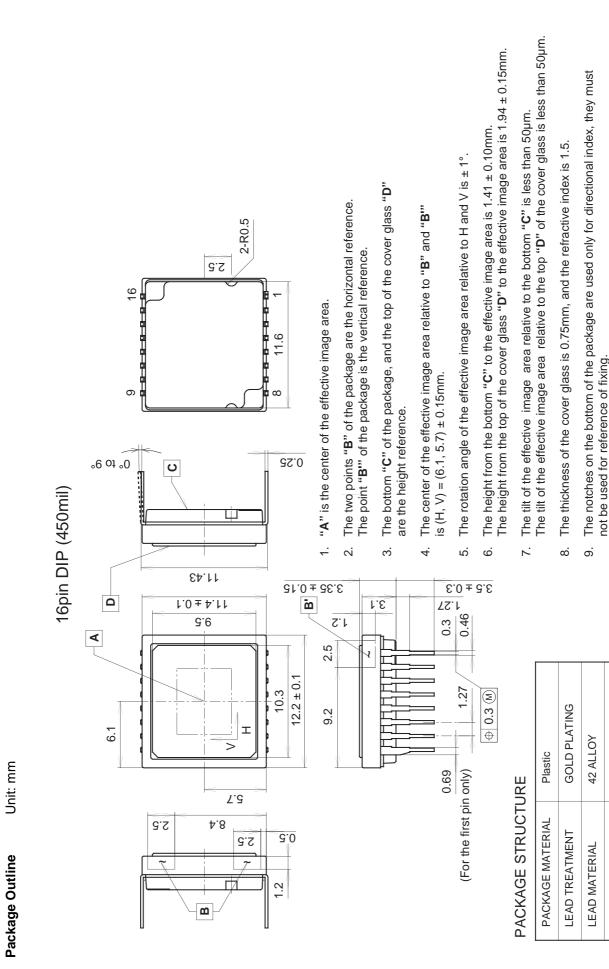
Torsional strength

b) If a load is applied to the entire surface by a hard component, bending stress may be generated and the package may fracture, etc., depending on the flatness of the bottom of the package. Therefore, for installation, use either an elastic load, such as a spring plate, or an adhesive.

- c) The adhesive may cause the marking on the rear surface to disappear, especially in case the regulated voltage value is indicated on the rear surface. Therefore, the adhesive should not be applied to this area, and indicated values should be transferred to the other locations as a precaution.
- d) The notch of the package is used for directional index, and that can not be used for reference of fixing. In addition, the cover glass and seal resin may overlap with the notch of the package.
- e) If the lead bend repeatedly and the metal, etc., clash or rub against the package, the dust may be generated by the fragments of resin.
- f) Acrylate anaerobic adhesives are generally used to attach CCD image sensors. In addition, cyanoacrylate instantaneous adhesives are sometimes used jointly with acrylate anaerobic adhesives. (reference)

5) Others

- a) Do not expose to strong light (sun rays) for long periods, color filters will be discolored. When high luminance objects are imaged with the exposure level control by electronic-iris, the luminance of the image-plane may become excessive and discolor of the color filter will possibly be accelerated. In such a case, it is advisable that taking-lens with the automatic-iris and closing of the shutter during the power-off mode should be properly arranged. For continuous using under cruel condition exceeding the normal using condition, consult our company.
- b) Exposure to high temperature or humidity will affect the characteristics. Accordingly avoid storage or usage in such conditions.
- c) The brown stain may be seen on the bottom or side of the package. But this does not affect the CCD characteristics.



0.9g

PACKAGE WEIGHT